



RECOMMENDED
PANEL CUTOUT DIMENSION

SUGGESTED PCB LAYOUT
TOP VIEW
DIMENSIONAL TOLERANCE: .XX ±0.08[0.003]

NOTES:

- MATERIALS:
HOUSING: NYLON POLYESTER UL94V-0 MIXED GLASS FIBER.
CONTACTS: T=0.35 mm PHOSPHOR BORNZE, 50µ" NICKEL
UNDERPLATE ON ALL AREA, 100µ" TIN ON TERMINATION
END, PLATED WITH 15µ" GOLD ON CONTACT AREA.
SHIELDED: T=0.25 mm COPPER ZINC ALLOY PLATED WITH NICKEL.
- SOLDER TEMPERATURE: 260°C
- OPERATING TEMPERATURE: -40°C~+85°C
- JACK CAVITY CONFORMS TO FCC RULES AND REGULATIONS
PART 68, SUBPART F
- UNSPECIFIED TOLERANCE: .XX ±0.25[0.010]
.X ±0.30[0.012]

RoHS Compliant

X MULTIPLE			CONNECTING THE INFORMATION AGE	
X MULTIPLE ASIA 4F, No. 347, Yang Guang St., Neihu Chiu, Taipei, Taiwan 11475		X MULTIPLE USA 1420 Los Angeles Ave., Suite G, Simi Valley, CA 93065		G/NO:
THIS DRAWING IS A CONTROLLED DOCUMENT.				DWG NO: XRJV-S-01-8-8-1-TE1
TITLE: RJ45 Jack, W/LED, 8P,8C, Shielded, Vertical Mount, Thru-Hole				DRAWN: LEON
PART NO: XRJV-S-01-8-8-1-TE1				CHKD: JEFF
		UNIT mm[Inch]	SHEET 1 of 1	REV 01
				DATE: Mar.14,08